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COLOR MONITOR

SERVICE MANUAL

CHASSIS NO. : LM95A

MODEL: FLATRON W2486L W2486L-PFV

CAUTION

BEFORE SERVICING THE UNIT,
READ THE **SAFETY PRECAUTIONS** IN THIS MANUAL.



P/NO : MFL61938704 (0904-REV00)

Printed in Korea

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PRECAUTION

WARNING FOR THE SAFETY-RELATED COMPONENT.

- There are some special components used in LCD monitor that are important for safety. **These parts are marked \triangle on the schematic diagram and the Exploded View.** It is essential that these critical parts should be replaced with the manufacturer's specified parts to prevent electric shock, fire or other hazard.
- Do not modify original design without obtaining written permission from manufacturer or you will void the original parts and labor guarantee.

TAKE CARE DURING HANDLING THE LCD MODULE WITH BACKLIGHT UNIT.

- Must mount the module using mounting holes arranged in four corners.
- Do not press on the panel, edge of the frame strongly or electric shock as this will result in damage to the screen.
- Do not scratch or press on the panel with any sharp objects, such as pencil or pen as this may result in damage to the panel.
- Protect the module from the ESD as it may damage the electronic circuit (C-MOS).
- Make certain that treatment person's body are grounded through wrist band.
- Do not leave the module in high temperature and in areas of high humidity for a long time.
- The module not be exposed to the direct sunlight.
- Avoid contact with water as it may a short circuit within the module.
- If the surface of panel become dirty, please wipe it off with a softmaterial. (Cleaning with a dirty or rough cloth may damage the panel.)

\triangle CAUTION

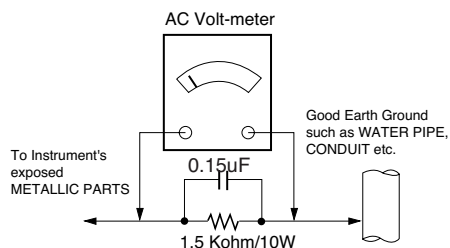
Please use only a plastic screwdriver to protect yourself from shock hazard during service operation.

\triangle WARNING

BE CAREFUL ELECTRIC SHOCK !

- If you want to replace with the new backlight (CCFL) or LIPS part, must disconnect the AC power because high voltage appears at inverter circuit about 650Vrms.
- Handle with care wires or connectors of the inverter circuit. If the wires are pressed cause short and may burn or take fire.

Leakage Current Hot Check Circuit



When 25A is impressed between Earth and 2nd Ground for 1 second, Resistance must be less than 0.1Ω
*Base on Adjustment standard

• Replaceable batteries

* CAUTION

RISK OF EXPLOSION IF BATTERY IS REPLACED BY AN INCORRECT TYPE.
DISPOSE OF USED BATTERIES ACCORDING TO THE INSTRUCTIONS

SERVICING PRECAUTIONS

CAUTION: Before servicing receivers covered by this service manual and its supplements and addenda, read and follow the **SAFETY PRECAUTIONS** on page 3 of this publication.

NOTE: If unforeseen circumstances create conflict between the following servicing precautions and any of the safety precautions on page 3 of this publication, always follow the safety precautions. Remember: Safety First.

General Servicing Precautions

1. Always unplug the receiver AC power cord from the AC power source before;
 - a. Removing or reinstalling any component, circuit board module or any other receiver assembly.
 - b. Disconnecting or re-connecting any receiver electrical plug or other electrical connection.
 - c. Connecting a test substitute in parallel with an electrolytic capacitor in the receiver.

CAUTION: A wrong part substitution or incorrect polarity installation of electrolytic capacitors may result in an explosion hazard.

2. Test high voltage only by measuring it with an appropriate high voltage meter or other voltage measuring device (DVM, FETVOM, etc) equipped with a suitable high voltage probe. Do not test high voltage by "drawing an arc".

3. Do not spray chemicals on or near this receiver or any of its assemblies.

4. Unless specified otherwise in this service manual, clean electrical contacts only by applying the following mixture to the contacts with a pipe cleaner, cotton-tipped stick or comparable non-abrasive applicator; 10% (by volume) Acetone and 90% (by volume) isopropyl alcohol (90%-99% strength)

CAUTION: This is a flammable mixture.

Unless specified otherwise in this service manual, lubrication of contacts is not required.

5. Do not defeat any plug/socket B+ voltage interlocks with which receivers covered by this service manual might be equipped.
6. Do not apply AC power to this instrument and/or any of its electrical assemblies unless all solid-state device heat sinks are correctly installed.
7. Always connect the test receiver ground lead to the receiver chassis ground before connecting the test receiver positive lead.

Always remove the test receiver ground lead last.

8. Use with this receiver only the test fixtures specified in this service manual.

CAUTION: Do not connect the test fixture ground strap to any heat sink in this receiver.

Electrostatically Sensitive (ES) Devices

Some semiconductor (solid-state) devices can be damaged easily by static electricity. Such components commonly are called Electrostatically Sensitive (ES) Devices. Examples of typical ES devices are integrated circuits and some field-effect transistors and semiconductor "chip" components. The following techniques should be used to help reduce the incidence of component damage caused by static by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed to prevent potential shock reasons prior to applying power to the unit under test.

2. After removing an electrical assembly equipped with ES devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.

3. Use only a grounded-tip soldering iron to solder or unsolder ES devices.

4. Use only an anti-static type solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ES devices.

5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ES devices.

6. Do not remove a replacement ES device from its protective package until immediately before you are ready to install it. (Most replacement ES devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive material).

7. Immediately before removing the protective material from the leads of a replacement ES device, touch the protective material to the chassis or circuit assembly into which the device will be installed.

CAUTION: Be sure no power is applied to the chassis or circuit, and observe all other safety precautions.

8. Minimize bodily motions when handling unpackaged replacement ES devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ES device.)

General Soldering Guidelines

1. Use a grounded-tip, low-wattage soldering iron and appropriate tip size and shape that will maintain tip temperature within the range of 500°F to 600°F.

2. Use an appropriate gauge of RMA resin-core solder composed of 60 parts tin/40 parts lead.

3. Keep the soldering iron tip clean and well tinned.

4. Thoroughly clean the surfaces to be soldered. Use a mall wire-bristle (0.5 inch, or 1.25cm) brush with a metal handle. Do not use freon-propelled spray-on cleaners.

5. Use the following unsoldering technique

- a. Allow the soldering iron tip to reach normal temperature. (500°F to 600°F)

- b. Heat the component lead until the solder melts.

- c. Quickly draw the melted solder with an anti-static, suction-type solder removal device or with solder braid.

CAUTION: Work quickly to avoid overheating the circuit board printed foil.

6. Use the following soldering technique.

- a. Allow the soldering iron tip to reach a normal temperature (500°F to 600°F)

- b. First, hold the soldering iron tip and solder the strand against the component lead until the solder melts.

- c. Quickly move the soldering iron tip to the junction of the component lead and the printed circuit foil, and hold it there only until the solder flows onto and around both the component lead and the foil.

CAUTION: Work quickly to avoid overheating the circuit board printed foil.

- d. Closely inspect the solder area and remove any excess or splashed solder with a small wire-bristle brush.

IC Remove/Replacement

Some chassis circuit boards have slotted holes (oblong) through which the IC leads are inserted and then bent flat against the circuit foil. When holes are the slotted type, the following technique should be used to remove and replace the IC. When working with boards using the familiar round hole, use the standard technique as outlined in paragraphs 5 and 6 above.

Removal

1. Desolder and straighten each IC lead in one operation by gently prying up on the lead with the soldering iron tip as the solder melts.
2. Draw away the melted solder with an anti-static suction-type solder removal device (or with solder braid) before removing the IC.

Replacement

1. Carefully insert the replacement IC in the circuit board.
2. Carefully bend each IC lead against the circuit foil pad and solder it.
3. Clean the soldered areas with a small wire-bristle brush. (It is not necessary to reapply acrylic coating to the areas).

"Small-Signal" Discrete Transistor Removal/Replacement

1. Remove the defective transistor by clipping its leads as close as possible to the component body.
2. Bend into a "U" shape the end of each of three leads remaining on the circuit board.
3. Bend into a "U" shape the replacement transistor leads.
4. Connect the replacement transistor leads to the corresponding leads extending from the circuit board and crimp the "U" with long nose pliers to insure metal to metal contact then solder each connection.

Power Output, Transistor Device Removal/Replacement

1. Heat and remove all solder from around the transistor leads.
2. Remove the heat sink mounting screw (if so equipped).
3. Carefully remove the transistor from the heat sink of the circuit board.
4. Insert new transistor in the circuit board.
5. Solder each transistor lead, and clip off excess lead.
6. Replace heat sink.

Diode Removal/Replacement

1. Remove defective diode by clipping its leads as close as possible to diode body.
2. Bend the two remaining leads perpendicular y to the circuit board.
3. Observing diode polarity, wrap each lead of the new diode around the corresponding lead on the circuit board.
4. Securely crimp each connection and solder it.
5. Inspect (on the circuit board copper side) the solder joints of the two "original" leads. If they are not shiny, reheat them and if necessary, apply additional solder.

Fuse and Conventional Resistor Removal/Replacement

1. Clip each fuse or resistor lead at top of the circuit board hollow stake.
2. Securely crimp the leads of replacement component around notch at stake top.
3. Solder the connections.

CAUTION: Maintain original spacing between the replaced component and adjacent components and the circuit board to prevent excessive component temperatures.

Circuit Board Foil Repair

Excessive heat applied to the copper foil of any printed circuit board will weaken the adhesive that bonds the foil to the circuit board causing the foil to separate from or "lift-off" the board. The following guidelines and procedures should be followed whenever this condition is encountered.

At IC Connections

To repair a defective copper pattern at IC connections use the following procedure to install a jumper wire on the copper pattern side of the circuit board. (Use this technique only on IC connections).

1. Carefully remove the damaged copper pattern with a sharp knife. (Remove only as much copper as absolutely necessary).
2. Carefully scratch away the solder resist and acrylic coating (if used) from the end of the remaining copper pattern.
3. Bend a small "U" in one end of a small gauge jumper wire and carefully crimp it around the IC pin. Solder the IC connection.
4. Route the jumper wire along the path of the out-away copper pattern and let it overlap the previously scraped end of the good copper pattern. Solder the overlapped area and clip off any excess jumper wire.

At Other Connections

Use the following technique to repair the defective copper pattern at connections other than IC Pins. This technique involves the installation of a jumper wire on the component side of the circuit board.

1. Remove the defective copper pattern with a sharp knife. Remove at least 1/4 inch of copper, to ensure that a hazardous condition will not exist if the jumper wire opens.
2. Trace along the copper pattern from both sides of the pattern break and locate the nearest component that is directly connected to the affected copper pattern.
3. Connect insulated 20-gauge jumper wire from the lead of the nearest component on one side of the pattern break to the lead of the nearest component on the other side. Carefully crimp and solder the connections.
CAUTION: Be sure the insulated jumper wire is dressed so the it does not touch components or sharp edges.

SPECIFICATIONS

1. General Specification

No	Item		Content	Remark
1	Customer		BRAND	
2	User Model Name		W2486L-PFV	
3	Sale region		World Wide	
4	Feature		24" LCD MONITOR	
5	Chassis Name		LM95A	
6	General Scope	External SW &Adj.	Smart, Fun, Menu, F-engine(▼), Source(▲) Auto/Select, Power	
		Function	OSD, DDC2B, DDC-CI, HDCP, Control Lock, sRGB, f-Engine, ARC, RTC, Auto bright, Over scan, ez zooming, photo effect, 4:3 in wide, headphone out, black level,	
7	Power Cord		Length : 1.87±0.05 M	
			Shape : Wall-out	
			Color : Black	
8	Cable	Signal Cable (D-SUB)	Length : 1.8±0.03M	
			Shape : Detachable Type	
			Color : Black	
			Pin : Triple Row, 15-Position Sub-miniature D	
	Cable	Signal Cable (DVI)	Length : 2.0±0.03 M	
			Shape : Detachable Type	
			Color : Black	
			Pin : Triple Row, 18-Position DVI-D	
9	Adqpter		Input: AC100~240V 50~60Hz, 1.0A Max	
10	Applying module list		Model P/No	Specification
			EAJ60678401	M240HW01 v1

2. Mechanical specification

No	Item		Content				Remark
1	Product Dimension	Before Packing	Width (W)		Length (D)	Height (H)	With stand
			577.4	198.4	440.5		
		Without stand	577.4	84.1	430		
		After Packing	654	492	126		
2	Product Weight	Only SET	4.7 Kg				
		With BOX	7.2 Kg				
3	Container Loading Quantity	Individual or Palletizing	20ft		40ft		
			Indi.	Pallet	Indi.	Pallet	
			684	576	1512	1344	
4	Stand Assy	Type	Attachable(Tilt Only)				
		Size (W x D x H)	256.1 * 198.4 * 26.6				
		Tilt Degree	-2°(±2) ~ 15°(±3)				
		Tilt force	0.8~2.5 kgf				
		Swivel Degree	N/A				
		Swivel Force	N/A				
5	Appearance	General	Refer to Standard of LG(56)G2-1011				

3. Optical Character

No	Item	Criteria		Remark
1	Viewing Angle <CR ≥10>	Horizontal(R/L) : +75°/-75°(min), +85°/-85°(Typ.)		
		Vertical(Top/Bottom) : +70°/-70°(min), +80°/-80° (Typ.)		
2	Luminance	Minimum Luminance(cd/m ²)	180(min) (Full white pattern, 0.70V)	6500K
		Brightness Uniformity	75%(min)	
3	Contrast Ratio	600(Min), 1000(Min) DFC-> 1,000,000:1(Min)		
4	Response Time	On/off:5ms(TYP), Gray to Gray: 2ms(TYP)		
5	Light Leakage	Condition: Do not visible at 300 Lux		

4. Engineering Specification

1	Supported Sync. Type	Separate Sync., SOG, Digital				Remarks
2	Operating Frequency	Analog/ Digital	Horizontal	30 ~ 83kHz		
			Vertical	56 ~ 75 Hz		
		HDMI	Horizontal	28 ~ 83kHz		
			Vertical	48 ~ 61 Hz		
3	Resolution	Analog/ Digital	Max.	1920x1080 @ 60Hz		
			Recommend	1920x1080 @ 60Hz		
		HDMI	Max.	1920x1080 @ 60Hz		
			Recommend	1920x1080 @ 60Hz		
4	Input Voltage	Voltage : 100 – 240 Vac, 50 or 60Hz				
5	Inrush Current	Cold Start : 50 A Hot : 120 A				
6	Operating Condition	Sync(H/V)	Video	LED	Wattage	Test condition 1. 1920x1080 @ 60Hz 2. burst pattern 3. 100~240V 4. After aging 30min
	On Mode	On/On	Active	RED	32W (Max) 28W (typ)	
	Sleep Mode	Off/On On/Off Off/Off	Off	blinking	1W	
	Off Mode (Power switch off)	-	-	Off	1W	
7	MTBF	50,000 HRS with 90% Confidence level		Lamp Life : 50,000 Hours(Min)		
8	Using Altitude	5,000 m (for Reliability) 3,000m(for FOS)				
9	Environment Condition	Operating	Temperature 10 °C ~ 35 °C			
			Humidity 10% ~ 80%			
	Storage	Temperature -20 °C ~ 60 °C				
		Humidity 5% ~ 90% non-condensing				

5. LCD Panel Characteristic

No	Item	Content	Remark				
1	LCD Module Feature	Maker	AUO				
		Type	TFT Color LCD Module				
		Active Display Area	24 inches (609.7mm) diagonal (Aspect ratio 16:10)				
		Pixel Pitch [mm]	0.2767mm x 0.2767mm				
		Electrical Interface	2ch-LVDS				
		Color Depth	16.7M colors (RGB 6-bit + Hi_FRC)				
		Size (Outline) [mm]	556.0(H) x 323.2(V) x 14.55(D) mm				
		Surface Treatment	Anti-Glare, Hard Coating (3H)				
		Operating Mode	Transmissive mode Normally White				
		Back light Unit	White LED				
		R/T	Typical	Rise Time: 3.4 , Fall Time: 1.6			
	Max.	Rise Time: 7.4 , Fall Time: 2.6					
2	CIE Color Coordinates		Minimum	Normal	Maximum		
		White	Wx	Typ-0.015	0.283	Typ+0.015	9300K
			Wy		0.298		
		White	u'	Typ-0.015	0.313	Typ+0.015	6500K
			v'		0.329		
		Red	Rx	Typ-0.03	0.635	Typ+0.03	
			Ry		0.349		
		Green	Gx		0.335		
			Gy		0.607		
		Blue	Bx		0.146		
			By		0.058		

(1) Standard Measurement Condition

- Ambient Luminance Level : dark (< 10 lux)
- Ambient Temperature : Normal Temperature(10 ~ 25°C)
- warm-up Time : More than 30min (at Full White Pattern)
- Input Signal : VESA 1920X1080+ 60Hz
- Contrast : 70 (But, the contrast is 100 when we check response time)
- Brightness : Max. 100
- 6500K : Color Temperature Setting is 6500 K(if it's not special specification)
- Clock/Clock Phase : The Best Setting

(2) Another Spec.: Product Specification Standard(LG(55)G1-1034)

(3) Cosmetic Spec. : LCD Module IIS Spec.

5.1 Display Area

1) Active Display Area of the LCD Monitor Should be within Cabinet's Bezel.

2) Distance Difference between Active Area and Bezel

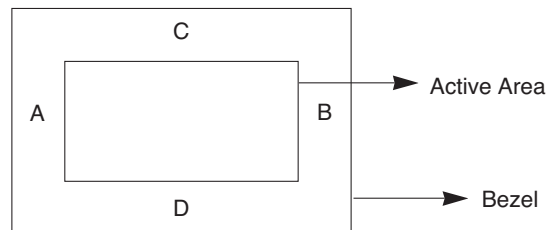
| A-B|<1.0 mm , | C-D|<1.0 mm

A: The Distance from The Left of Active Area to the Bezel

B: The Distance from The Right of Active Area to the Bezel

C: The Distance from The Top of Active Area to the Bezel

D: The Distance from The Bottom of Active Area to the Bezel



6. EDID

6.1 EDID

No	Item	Content	Hexadecimal Data
1	Manufacturer ID	GSM	1E 6D
2	Product ID	22306(Analog)	5722
		22307(Digital)	5723
		22313(HDMI1)	5729
3	Year	2009	13
4	Version	Analog : 1	01
		Digital : 1	
		HDMI : 1	
5	Revision	Analog : 3	03
		Digital : 3	
		HDMI: 3	
6	Model Name	W2486	--
7	Special Item	White LED module	

6.2.3 EDID Ver. 1.3 For HDMI1

```

Addr 00 01 02 03 04 05 06 07 08 09 0A 0B 0C 0D 0E 0F
0000 00 FF FF FF FF FF FF 00 1E 6D 29 57 01 01 01 01
0010 01 13 01 03 80 35 1E 78 0A 3F 35 A2 59 55 9B 25
0020 0E 50 54 21 08 00 B3 00 81 80 81 40 71 40 01 01
0030 01 01 01 01 01 01 1A 36 80 A0 70 38 1F 40 30 20
0040 35 00 13 2B 21 00 00 1A 02 3A 80 18 71 38 2D 40
0050 58 2C 45 00 13 2B 21 00 00 1E 00 00 00 FD 00 30
0060 3D 1C 53 0F 00 0A 20 20 20 20 20 20 00 00 00 FC
0070 00 57 32 34 38 36 0A 20 20 20 20 20 20 01 94
0080 02 03 21 F1 4E 90 04 03 01 14 12 05 1F 10 13 00
0090 00 00 00 23 09 07 07 83 01 00 00 65 03 0C 00 10
00A0 00 02 3A 80 18 71 38 2D 40 58 2C 45 00 13 2B 21
00B0 00 00 1E 01 1D 80 18 71 1C 16 20 58 2C 25 00 13
00C0 2B 21 00 00 9E 01 1D 00 72 51 D0 1E 20 6E 28 55
00D0 00 13 2B 21 00 00 1E 8C 0A D0 8A 20 E0 2D 10 10
00E0 3E 96 00 13 2B 21 00 00 18 00 00 00 00 00 00 00
00F0 00 00 00 00 00 00 00 00 00 00 00 00 00 00 00 26
    
```

6.2 Data (128 Bytes)

6.2.1 EDID Ver. 1.3 For ANALOG

```

Addr 00 01 02 03 04 05 06 07 08 09 0A 0B 0C 0D 0E 0F
0000 00 FF FF FF FF FF FF 00 1E 6D 22 57 01 01 01 01
0010 01 13 01 03 6A 35 1E 78 EA 3F 35 A2 59 55 9B 25
0020 0E 50 54 A7 6B 80 B3 00 81 80 81 40 71 4F 01 01
0030 01 01 01 01 01 01 02 3A 80 18 71 38 2D 40 58 2C
0040 45 00 13 2B 21 00 00 1E 21 39 90 30 62 1A 27 40
0050 68 B0 36 00 13 2B 21 00 00 1C 00 00 00 FD 00 38
0060 4B 1E 53 0F 00 0A 20 20 20 20 20 20 00 00 00 FC
0070 00 57 32 34 38 36 0A 20 20 20 20 20 20 00 F1
    
```

6.2.2 EDID Ver. 1.3 For DIGITAL

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Addr 00 01 02 03 04 05 06 07 08 09 0A 0B 0C 0D 0E 0F
0000 00 FF FF FF FF FF FF 00 1E 6D 23 57 01 01 01 01
0010 01 13 01 03 80 35 1E 78 EA 3F 35 A2 59 55 9B 25
0020 0E 50 54 A7 6B 80 B3 00 81 80 81 40 71 4F 01 01
0030 01 01 01 01 01 01 1A 36 80 A0 70 38 1F 40 30 20
0040 35 00 13 2B 21 00 00 1A 02 3A 80 18 71 38 2D 40
0050 58 2C 45 00 13 2B 21 00 00 1E 00 00 00 FD 00 38
0060 4B 1E 53 0F 00 0A 20 20 20 20 20 20 00 00 00 FC
0070 00 57 32 34 38 36 0A 20 20 20 20 20 20 00 2B
    
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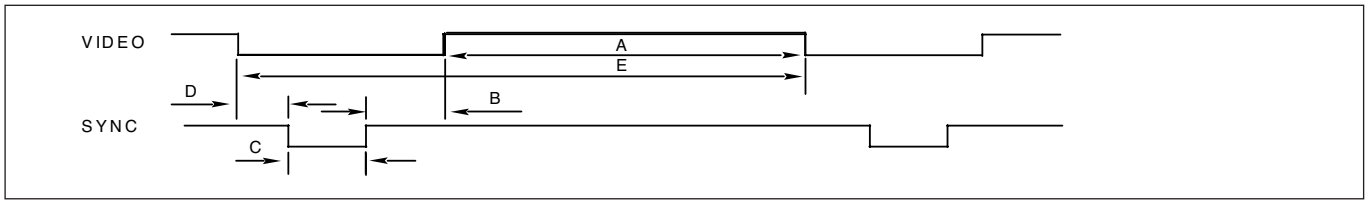
6.2.4 EDID Ver. 1.3 For HDMI2

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Addr 00 01 02 03 04 05 06 07 08 09 0A 0B 0C 0D 0E 0F
0000 00 FF FF FF FF FF FF 00 1E 6D 29 57 01 01 01 01
0010 01 13 01 03 80 35 1E 78 0A 3F 35 A2 59 55 9B 25
0020 0E 50 54 21 08 00 B3 00 81 80 81 40 71 40 01 01
0030 01 01 01 01 01 01 1A 36 80 A0 70 38 1F 40 30 20
0040 35 00 13 2B 21 00 00 1A 02 3A 80 18 71 38 2D 40
0050 58 2C 45 00 13 2B 21 00 00 1E 00 00 00 FD 00 30
0060 3D 1C 53 0F 00 0A 20 20 20 20 20 20 00 00 00 FC
0070 00 57 32 34 38 36 0A 20 20 20 20 20 20 01 94
0080 02 03 21 F1 4E 90 04 03 01 14 12 05 1F 10 13 00
0090 00 00 00 23 09 07 07 83 01 00 00 65 03 0C 00 20
00A0 00 02 3A 80 18 71 38 2D 40 58 2C 45 00 13 2B 21
00B0 00 00 1E 01 1D 80 18 71 1C 16 20 58 2C 25 00 13
00C0 2B 21 00 00 9E 01 1D 00 72 51 D0 1E 20 6E 28 55
00D0 00 13 2B 21 00 00 1E 8C 0A D0 8A 20 E0 2D 10 10
00E0 3E 96 00 13 2B 21 00 00 18 00 00 00 00 00 00 00
00F0 00 00 00 00 00 00 00 00 00 00 00 00 00 00 00 16
    
```

TIMING CHART

(1) Signal(Video & Sync)



(2) H/V Timing

Mode	Classification	Sync Polarity	Dot Clock	Frequency	Total Period (E)	Disply (A)	Front Porch (D)	Sync. (C)	Back porch(B)	Resolution
1	H(Pixels)	-	28.321	31.468	900	720	18	108	54	720 X400
	V(Lines)	+		70.08	449	400	12	2	35	
2	H(Pixels)	-	25.175	31.469	800	640	16	96	48	640 x480
	V(Lines)	-		59.94	525	480	10	2	33	
3	H(Pixels)	-	31.5	37.5	840	640	16	64	120	640 x480
	V(Lines)	-		75	500	480	1	3	16	
4	H(Pixels)	+	40.0	37.879	1056	800	40	128	88	800 x600
	V(Lines)	+		60.317	628	600	1	4	23	
5	H(Pixels)	+	49.5	46.875	1056	800	16	80	160	800 x600
	V(Lines)	+		75.0	625	600	1	3	21	
6	H(Pixels)	-	65.0	48.363	1344	1024	24	136	160	1024 x768
	V(Lines)	-		60.0	806	768	3	6	29	
7	H(Pixels)	-	78.75	60.123	1312	1024	16	96	176	1024x768
	V(Lines)	-		75.029	800	768	1	3	28	
8	H(Pixels)	+/-	108.0	67.500	1600	1152	64	128	256	1152x 864
	V(Lines)	+/-		75.000	900	864	1	3	32	
9	H(Pixels)	+	108.0	63.981	1688	1280	48	112	248	1280 x1024
	V(Lines)	+		60.02	1066	1024	1	3	38	
10	H(Pixels)	+	135.0	79.976	1688	1280	16	144	248	1280 X1024
	V(Lines)	+		75.035	1066	1024	1	3	38	
11	H(Pixels)	+	119	64.674	1840	1680	48	32	80	1680 X1050
	V(Lines)	-		59.883	1080	1050	3	6	21	
12	H(Pixels)	-	146.25	65.290	2240	1680	104	176	280	1680 X1050
	V(Lines)	+		59.954	1089	1050	3	6	30	
13	H(Pixels)	+	148.50	67.50	2200	1920	88	44	148	1920 X1080
	V(Lines)	+		60	1125	1080	4	5	36	

• D-SUB/DVI DTV Mode is not supported (interlace mode)

(3) HDMI Video input

	Factory support mode (Preset Mode)	Horizontal freq. (KHz)	Vertical freq. (Hz)
1	480P	31.5	60
2	576P	31.25	50
3	720P	37.5	50
4	720P	45	60
5	1080i	28.12	50
6	1080i	33.75	60
7	1080P	56.25	50
8	1080P	67.5	60

• HDMI jack is for AV(video signal)

ADJUSTMENT

1. Coverage

Apply to 24" Wide monitor made in Monitor Factory(Kumi Korea) or made in accordance with the standard of Kumi Factory process.

2. Appointment

2.1 Adjustment must be done as fixed sequence, and adjustment sequence can be modified after agreement with the responsible R&D engineer considering mass-production condition.

2.2 Power : AC100~240 Voltage (Free)

2.3 Input signal : As Product Standard (Signal ROM: W2286I V0.1)

2.4 Warm-up Time : Over than 5 minutes

2.5 Adjustment equipment : White balance equipment (CA-110/210), Display adjust equipment, VG-819(or VG828), Oscilloscope, PC (More than 486 computer) & White balance adjust program.,HDCP Adjusting Jig equipment.

3. Adjustment

3.1 Overview

Use factory automation equipment and adjust automatic movement. But, do via passivity adjust in error occurrence.

3.2 Adjustment order

(refer to the Adjustment standard and adjustment command table)

3.2.1 Board Assembly Line

- Connect input signal to 15pin D-sub.
- Ready for adjustment : check whether adjustment command works normally or not and the operating state of each mode. Check the display state of gray color when 256 gray scale pattern is embodied.
- Read by EEPROM Read Command to check whether initial value is correct or not.

3.2.2 Total Assembly Line

- Input analog signal. (1920x 1080@60Hz)
- Write HDCP Key to EEPROM(24C16) by using DDC2AB protocol&HDCP Adjusting equipment [Address 0xAC 80, 289 btes]
- If error is occurred, write and check again.
- Ready : Heat-run during 5 minutes in the state with signal
- Connect input signal to D-sub.
- Default value before adjustment : Contrast "70" , Brightness "100(Max)"

3.2.3 Adjustment of Horizontal/Verticality screen position, Clock and Clock Phase at each Mode.

- There is no special factory mode adjustment. Writing initial value of EEPROM in Board Assembly line is adjusting Preset Mode and Reset mode. (EEPROM is initialized when AC Power is ON first.)
- If the change of FOS data is needed after M.P, it is possible by writing Mode Data with EEPROM write command or modifying the Mode Data in MICOM itself.

Caution) Must keep power-on more than 3 seconds after AC Power-on first time.

3.2.4 Color coordinates adjustment and Luminance adjustment.

3.2.4.1 Color coordinates adjustment

- Monitor Contrast / Brightness
 - Contrast : 70
 - Brightness : 100(Max)
- CA-110/210: Set "Channel 7" ->
 - CA-110: channel8. CA-210: channel5
- Signal Generator : At cut-off and drive ->
 - 16 step pattern for ADC
 - Output Voltage : 700 mVp-p
 - Output Mode : Mode 13(WSXGA+ 60Hz)mode Setting.

3.2.4.2. Adjustment : Board Assembly Line

- Input 16 step pattern for ADC (Mode13, pattern 11). (Video level : 700 mVp-p)
- Adjust by commanding AUTO_COLOR_ADJUST Confirm "Success" message in Screen or Check the data of 0xFE, 0xFF address of EEPROM(0xA6) is 0xAA after waiting 5 seconds
- If there is "FAULT" message or the data of 0xFE, 0xFF address of EEPROM(0xAA) is not 0xAA, do adjust again
- If all Adjustment is completed, the values of 6500K, User Color and 9300K are saved automatically.

3.2.4.3. Confirm at Total Assembly Line: adjustment

- Check the data of 0xFE, 0xFF address of EEPROM(0xA6) is 0xAA.
- If the data of 0xFE, 0xFF address of EEPROM(0xA6) is not 0xAA, do adjust again by 3.2.4.2.

3.2.4.4. Confirm PRESET 6500K Color coordinates and Adjust PRESET 9300K Color coordinates .

- Set as Aging mode ON, by commanding AGING_ON/OFF command code.
- Select Module that is being used in present production by commanding MODULE SELECT.
- Send SYSTEM RESET command to set Module data.
- Input Full White Pattern (Video level : 700 mVp-p)
- Set as 9300K by commanding COLOR_MODE_CHANGE Command code.
- Adjust to meet $x = 0.283 \pm 0.004$, $y = 0.298 \pm 0.004$, and confirm.
- Save 9300K Color by commanding COLOR_SAVE Command code.
- Input Full White Pattern (Video level : 700 mVp-p)
- Set as 6500K by commanding COLOR_MODE_CHANGE Command code.
- 6500K color adjustment
 - It's not TCO model.
 - Don't need to adjust 6500K color.
 - If this TCO 03 spec should be satisfied later, refer to below method.
 - Adjust to meet $x = 0.313 \pm 0.007$, $y = 0.329 \pm 0.007$, and confirm.

* (Option)

It's another method for 6500K color adjustment at Gumi & NT. At first, check ΔUV . If that is under 0.0065, the set is not adjusted. If not. It is adjust to meet $u' = 0.198 \pm 0.0065$, $v' = 0.469 \pm 0.0065$

- Set as sRGB by commanding COLOR_MODE_CHANGE Command code.
- Adjust to meet $Y = 180 \pm 10$, and confirm.

3.2.4.5. Confirm User color coordinates .

- Confirm Whether User color is saved same as 6500K.
- After confirming Color coordinates, **Must return to 6500K**
- Confirm whether user color is 50. If the value of user color(R/G/B) is 30, do adjust again by 3.2.4.2.

3.2.5 Confirm Operation state.

3.2.5.1 Operation mode : Confirm whether each appointed mode operate correctly or not.

3.2.5.2 Confirmation of Adjustment condition and operation : Confirm whether it meet Auto/Manual equipement Adjustment standard or not.

For W2086T

- Confirm Analog screen state : Confirm screen state at below mode.
Appointment mode : 640*480 @60Hz (Mode 2),
800*600@75Hz(Mode 5), 1024*768@60Hz(Mode 6),
1280*1024@60Hz(Mode 9), 1680*1050@60HZ(Mode 11),
1920*1080@60HZ(Mode 12)
SMPTE pattern(Check 0%,5%,95%,100%) –Mode can be added.
- Check HDCP signal screen by using Video generator that generate HDCP signal

3.2.5.3. Confirm Auto adjustment operation.

- Input Analog 1 Dot on/off & Rectangle Pattern at Mode12(1920*1080@60Hz)
- Confirm adjustment operation by changing Clock, Phase,H/V Position.
- Check Clock, Phase by pressing AUTO Key.
- Confirm first set of new lot by periods

3.2.5.4 Other quality

- Confirm that each items satisfy under standard condition that was written product spec.
- Confirm Applying Module & MICOM Setting -> Confirm with Service OSD
-> Confirm at Service OSD by "Menu + Power key" on .(from Power off)
-> Confirm first set of new lot by periods, and confirm periodically when there is Process change or Adjustment setting change.

3.2.5.5. OSD & Adjustment device Confirmation : Confirm operation mentioned as product spec.

- Vary Brightness and Contrast and confirm the variation of Luminance and display status.
- Operate the f-engine function and confirm variation of Luminance.
- Make sure to do FACTORY RESET after confirmation of OSD function.

3.2.5.6. Confirm the display state by inputting 8 color Bar Pattern & 256 Gray Scale pattern.

3.2.5.7. DPM operation confirmation : Check if Power LED Color and Power Consumption operates as standard.

- Measurement Condition : 230V@ 50Hz (Analog)
- Confirm DPM operation at the state of screen without Video Signal.

3.2.5.8. DDC EDID Write

- HDMI part EDID data
- Confirm whether module selection is correct or not on the self-diagnostics OSD with signal cable disconnected.
- Connect HDMI Signal Cable to DVI-D wafer.
- Write EDID DATA to EEPROM(24C02) by using DDC2B protocol.
- Check whether written EDID data is correct or not.

- DVI part EDID data
- Confirm whether module selection is correct or not on the self-diagnostics OSD with signal cable disconnected.
- Connect Digital Signal Cable to DVI-D wafer.
- Write EDID DATA to EEPROM(24C02) by using DDC2B protocol.
- Check whether written EDID data is correct or not.

- Analog part EDID data
- Connect analog Signal Cable to D-sub wafer.
- Write EDID DATA to EEPROM(24C016) by using DDC2AB protocol. [Address 0xA6 00]
- Check whether written EDID data is correct or not. (refer to Product spec).

=> After writing EDID, send Elapsed Time Clear command. (Elapsed time should not be displayed, after EDID writing)
: Confirm periodically (in the first set of new lot, process change) whether module name and aging time disappeared on the self-diagnostics OSD with signal cable disconnected.

-> If Elapsed Time Clear command isn't executed, module name, aging time and TCO word appear on the self-diagnostics OSD.(Module name and aging time should not appear after writing EDID)

-> Make sure to do FACTORY RESET at the final process.

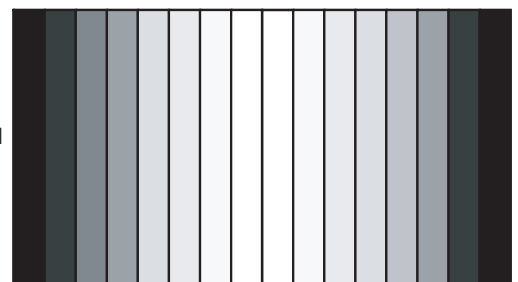
5. Standard of Auto/Manual equipment adjustment

No .	Item		Adjustment & measurement standard		Operation mode	Operation Pattern	Measurement Position	
1	Voltage(V)		5V± 0.3V / 3.3V±0.25V, 1.8V± 0.07		MODE 12	Pattern4	TP of Each power	
2	Color coordinates (9300/6500K)	Black Level	Auto Adjustment		MODE 13	Pattern 0	Center of Screen	
3	Color coordinates (6500K)	DRIVE1	X	0.313±0.004	MODE 13	Pattern1	Centerof Screen	
			Y	0.329±0.004				
			u'	0.198±0.02				
			v'	0.468±0.02				
	Color coordinates (9300K)	DRIVE2	X	0.283±0.004				
		Y	0.298±0.004					
	Luminance	6500K	More than 210cd/m2		MODE 13 (700mVp-p)	Pattern1	Center of Screen	
4	Screen Position		FULL SIZE		MODE 1-13	Pattern4	Full Screen	
5	Screen Compensation	Clock phase	FULL SIZE		MODE 13	Pattern 4	Full screen	
		AUTO	FULL SIZE		MODE 13	Pattern 4	Full screen	
6	DPM Confirmation	On Mode	32W(Max)		MODE 13	note1	RED	
			29W(typ)					
		Sleep Mode	≤1W				Pattern 6/7/8	Blinking
		Off Mode	≤1W					Off
7	SOG signal Confirmation		Input SOG signal		MODE 13	Pattern 9	Full screen	
8	Gray scale Confirmation		Linear gray Scale		MODE 13	Pattern 9	Full screen	
9	Withstanding Voltage		When 1500Vac or 2131Vdc is impressed between the first of power (Live/Neutral) and ground (Earth) for 1 second, check whether something wrong happens or not.					
10	Ground Confirmation		When 25A is impressed between Earth and 2 nd Ground for 1 second, Resistance must be less than 0.1 Ω					
11	Cutoff/ADC Adjustment Pattern		16 step pattern for ADC 1600 * 900 (700mVp-p) W2086T		MODE 13	Patten11		

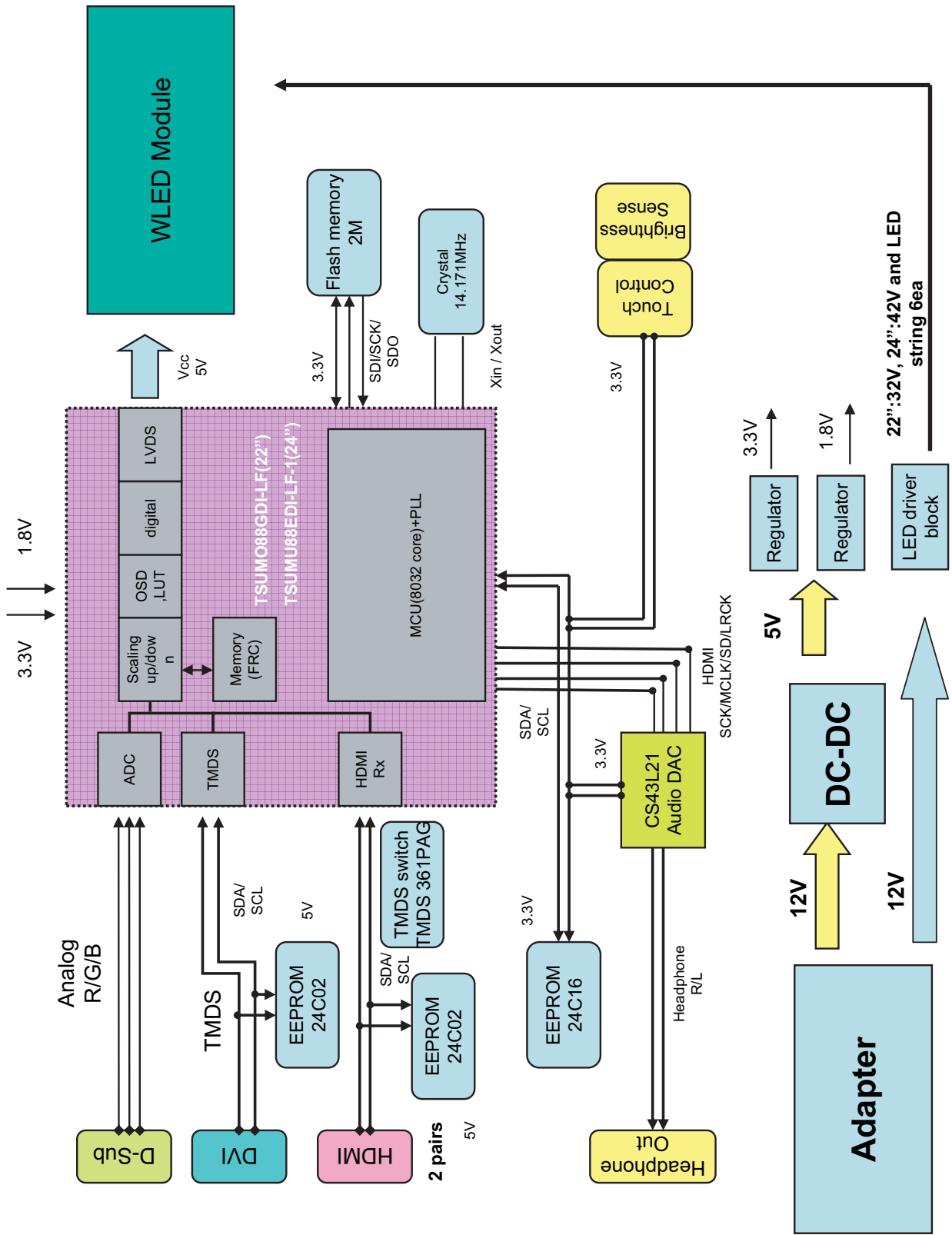
*Note 1 (Test condition):
 - mode12(1920x1080 @60Hz)
 - Burst pattern
 - 100V ~ 240Vac
 - Analog & Digital
 - After aging 30min

4. Pattern for Adjustment

Pattern 0 : FULL BLACK (State of without video signal)
 Pattern 1 : FULL WHITE (Don't display other Character except for White Pattern)
 Pattern 3 : FULL WHITE
 Pattern 4 : Cross hatch pattern (Horizontal 10Line, Vertical 8Line) & Rectangle Pattern
 Pattern 5 : 1 Dot on, 1 Dot off & Rectangle Pattern
 Pattern 6 : Vertical Sync only input (Use signal cable of which Pin #5 is GND)
 Pattern 7 : Horizontal Sync only input (Use signal cable of which Pin #5 is GND)
 Pattern 8 : State of without Vertical/Horizontal Sync and Video Signal. (Use signal cable of which Pin #5 is GND)
 Pattern 9 : 8 Color Bar Pattern + 16 Gray Level Pattern
 Pattern 10 : SMPTE Pattern
 Pattern 11 : 16 Gray Step Pattern (700mV)

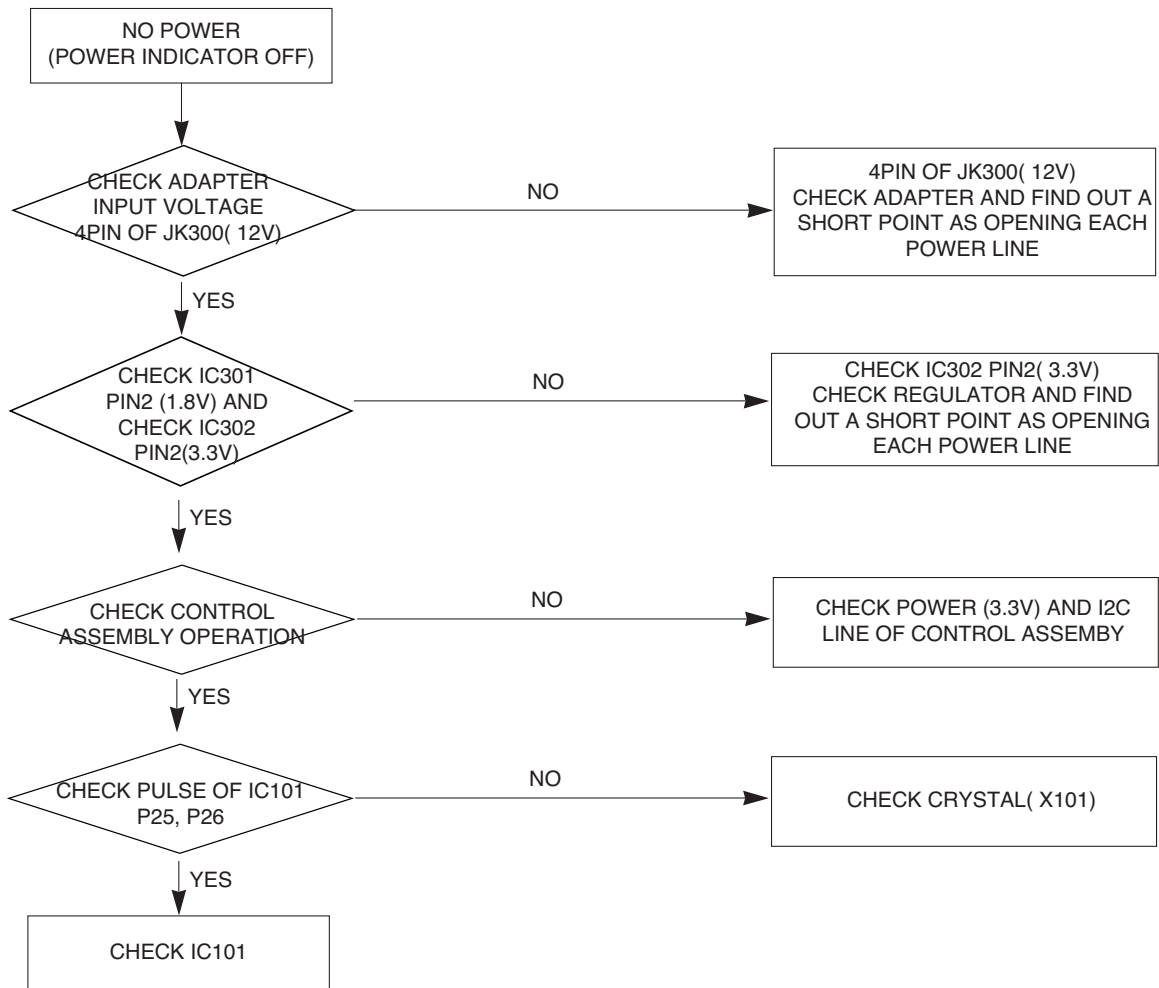


BLOCK DIAGRAM

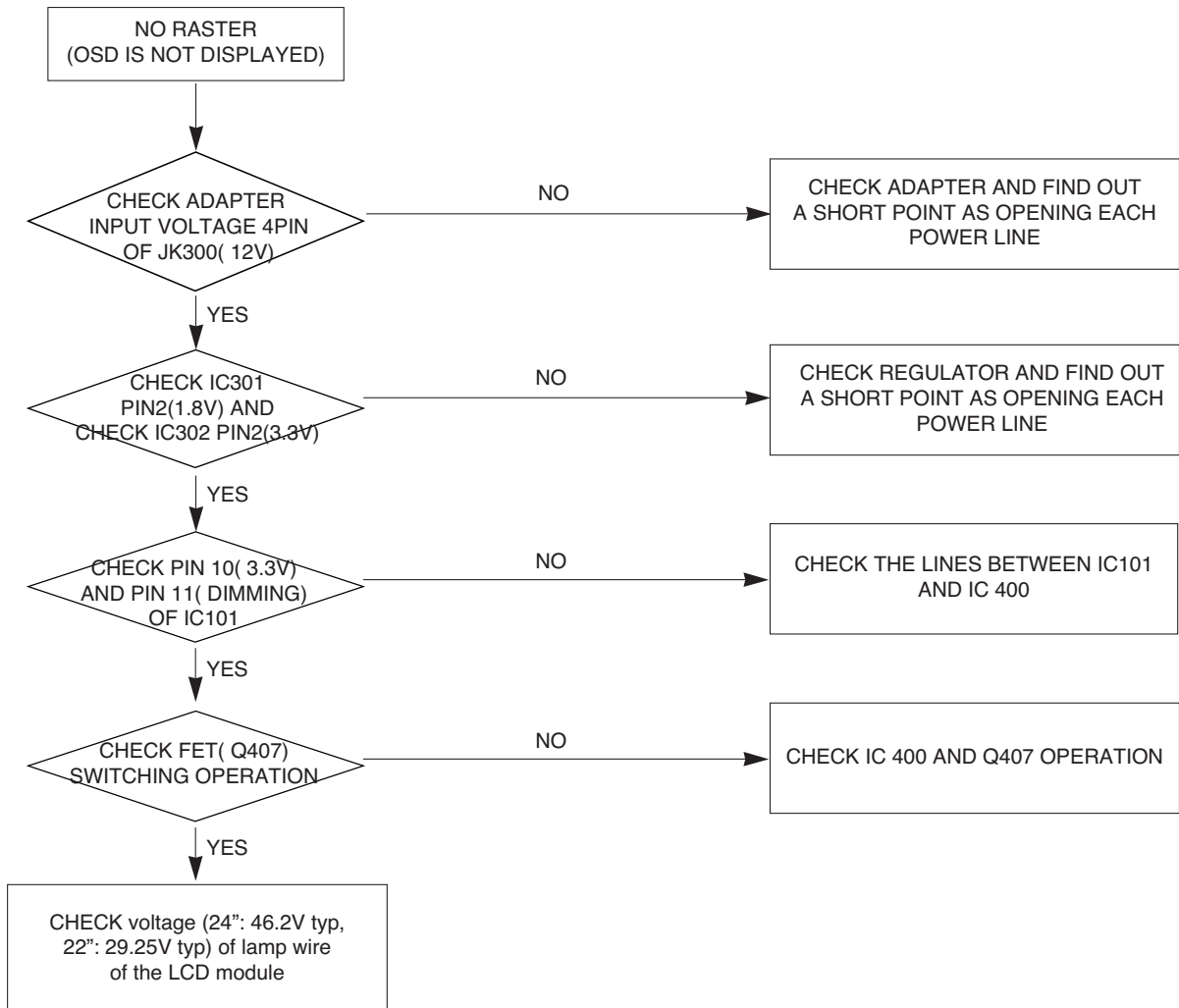


TROUBLESHOOTING GUIDE

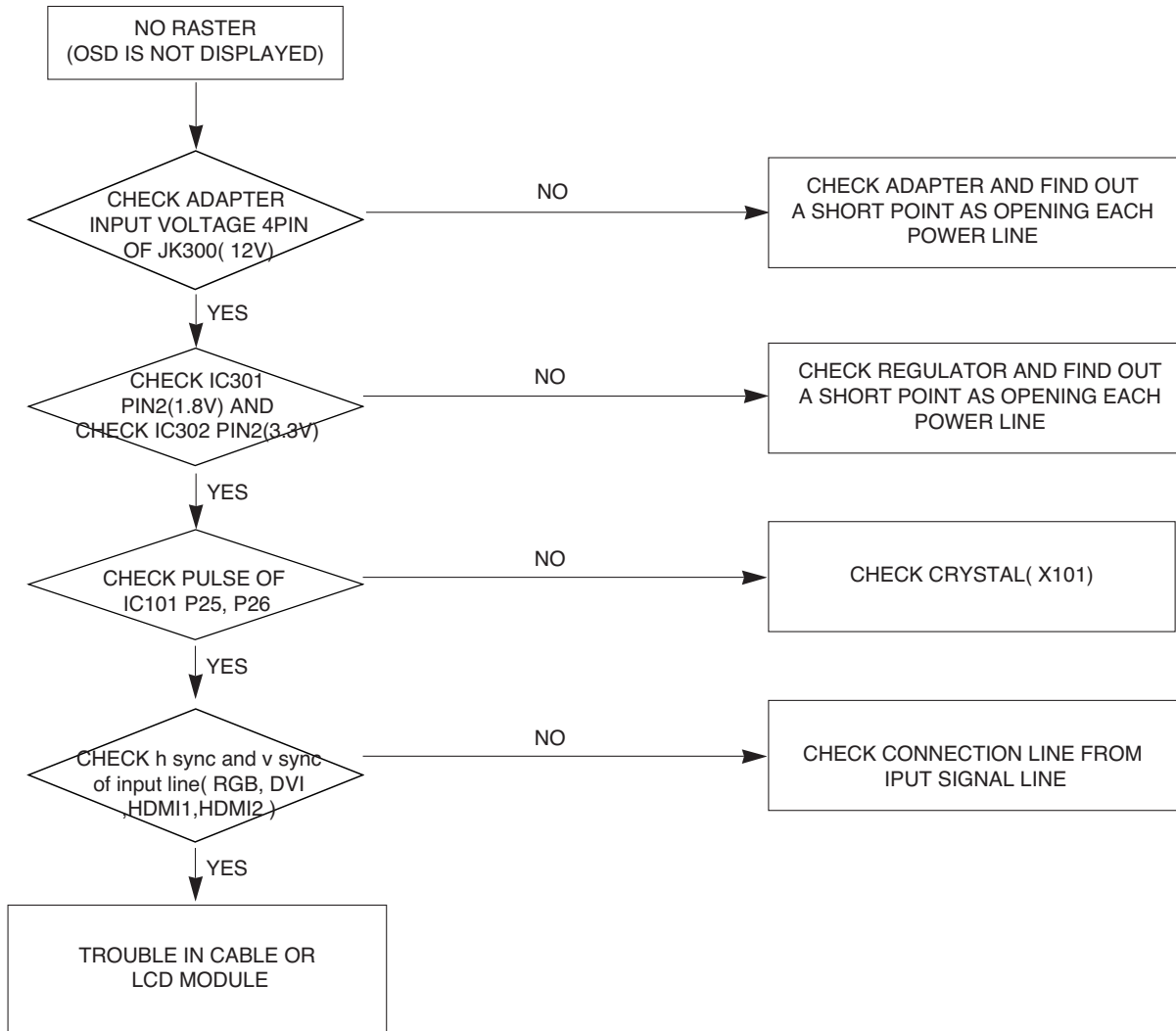
1. NO POWER



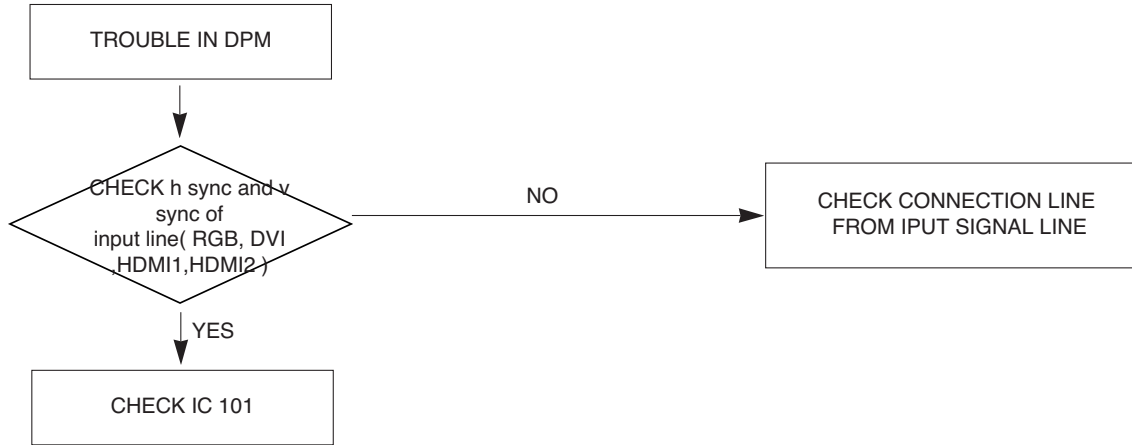
2. NO RASTER (OSD IS NOT DISPLAYED) – INVERTER



3. NO RASTER (OSD IS NOT DISPLAYED) – Mstar



4. TROUBLE IN DPM



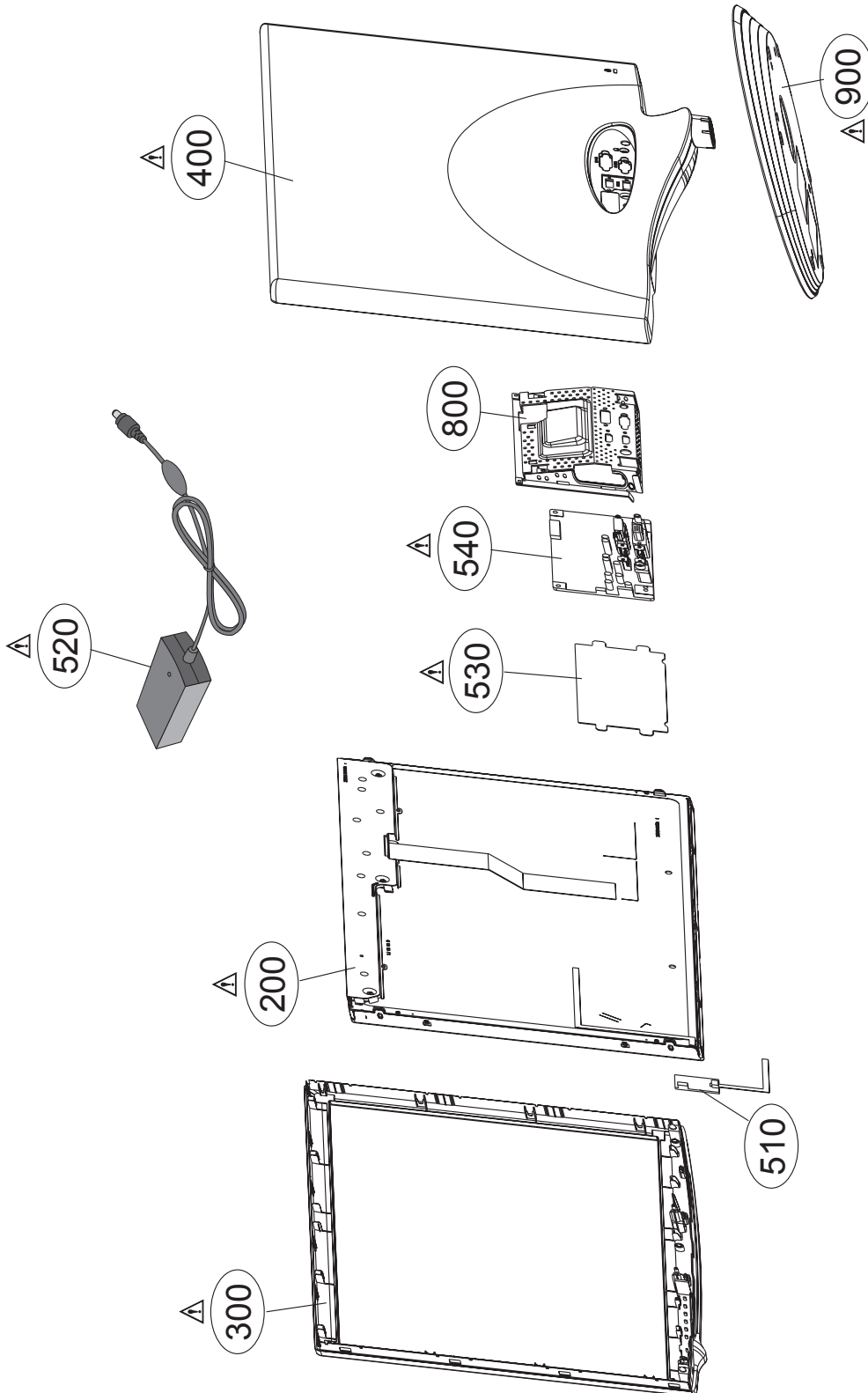
EXPLODED VIEW

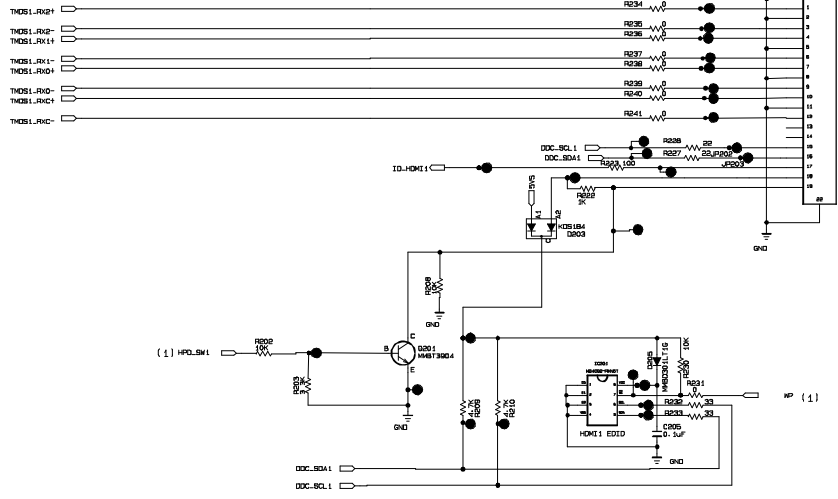
IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by Δ in the Schematic Diagram and EXPLODED VIEW.

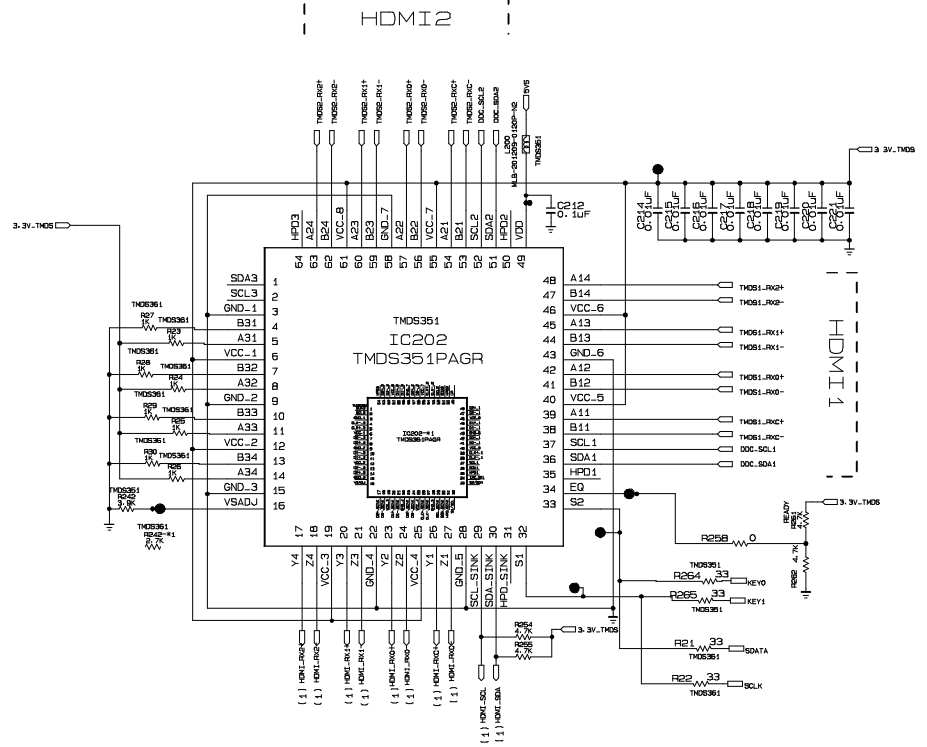
It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent X-RADIATION, Shock, Fire, or other Hazards.

Do not modify the original design without permission of manufacturer.

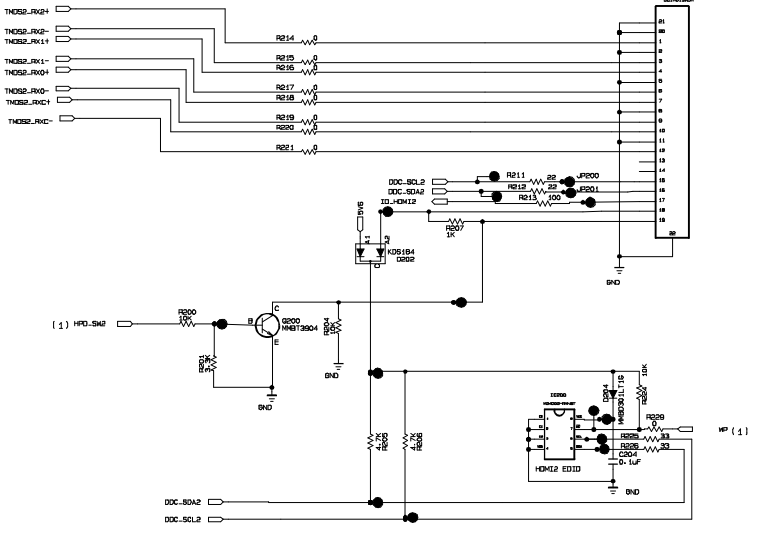




HDMI 1



HDMI 2



HDMI 2

